



CDF ISL Cooling Update

Peter Wilson

All Experimenters Meeting

July 2, 2007



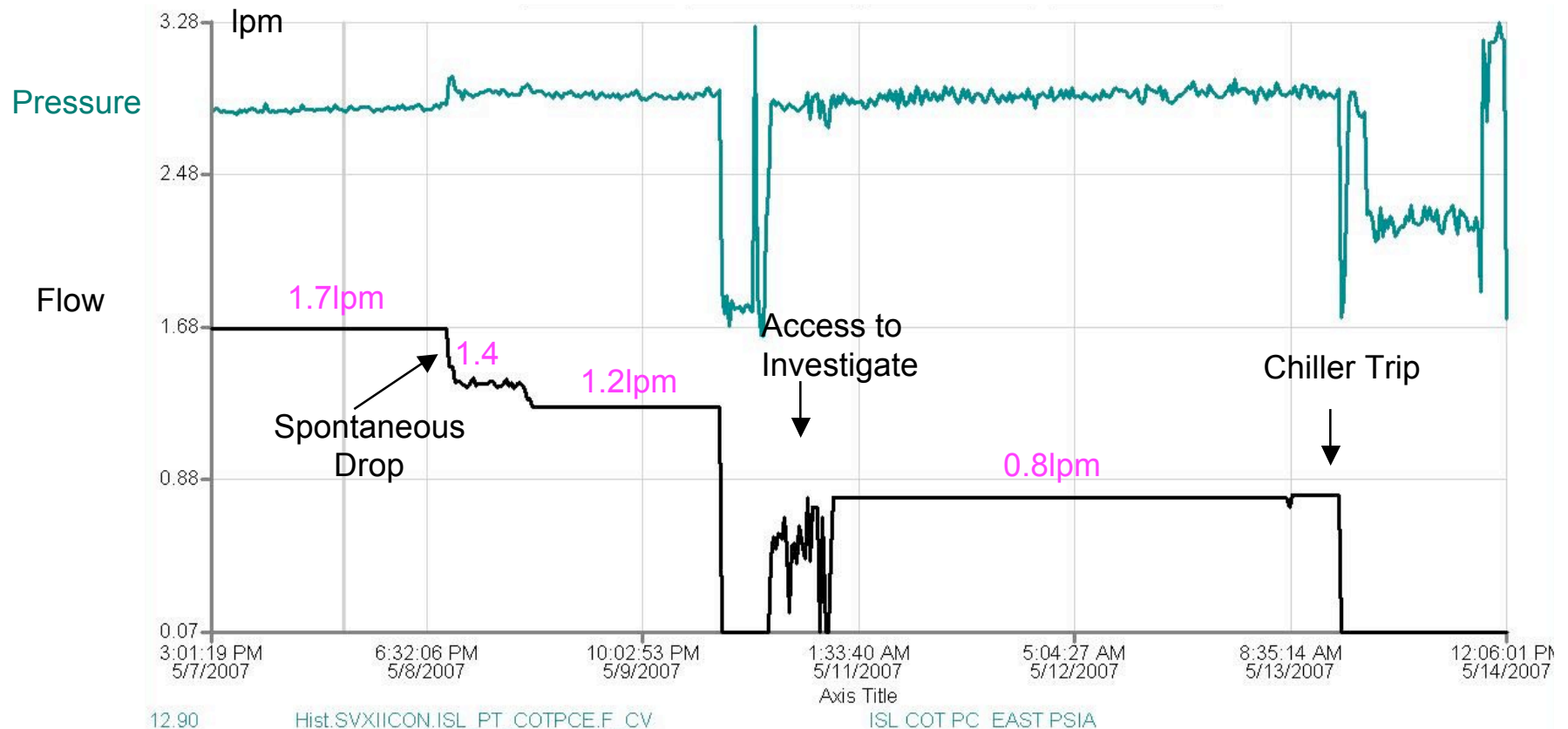
Overview

- Leak in cooling for Intermediate Silicon Layers (ISL) and Layer 00 Port Cards
 - Leak isolated to aluminum manifold on detector
 - Operating all SVX and west half of L00, ISL
- Taskforce looking at Cause, Repair method, Vulnerability and mitigation
 - Likely cause: corrosion by acidic coolant
 - Repair method developed
 - Evaluating vulnerabilities and mitigation
- Planning for 1 day access to repair next week
- Planning for the August shutdown



ISL Cooling Leak

- May 8-13 flow in East ISL/L00 portcard circuit dropped from 1.7 lpm (nominal) to 0.0 lpm:





Since the Leak

- May 16: Bore Access Found leak in portcard ring
 - SVX operating on next store, lost 2 1/2 stores
- May 24: First weekly ISL Task force Meeting
- May 26: Update cooling interlocks and re-establish operation of west half of L00/ISL
- June 4: Flow dry N2 through east portcard cooling line
- June 6: Restart flow of coolant through east ISL ladder cooling lines

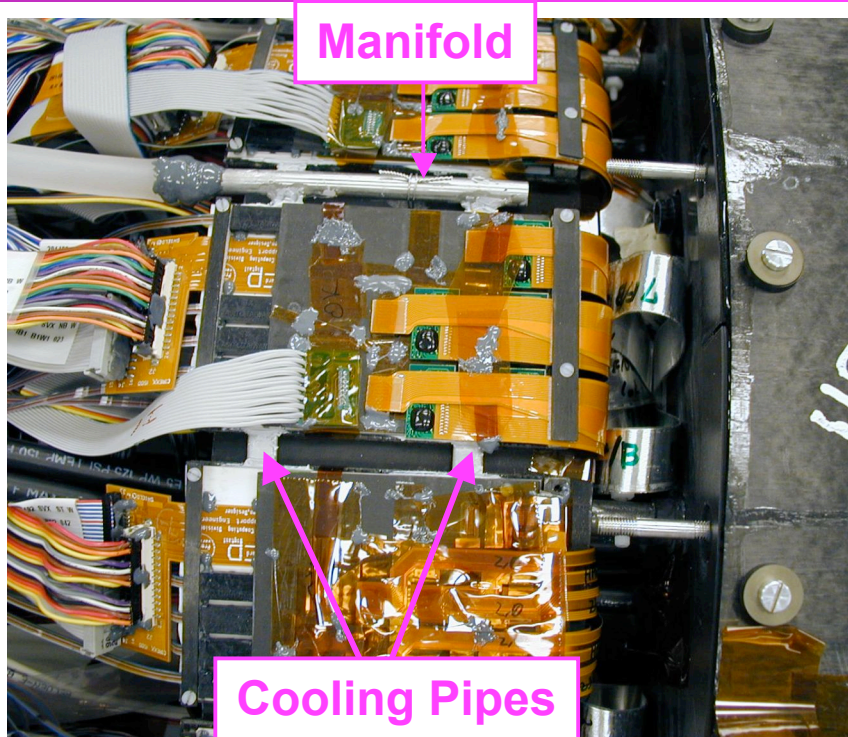


ISL Task Force: Lines of Attack

- Understand probable cause of leak
 - Goals:
 - Understand impact on method of repair
 - Prevent future problem
 - History of cooling system and coolant
 - Analysis of coolant and corrosion
 - Working with experts from industry and other labs (Argonne, CERN)
- Explore vulnerabilities in whole of system
 - Inventory of materials in system
 - Research on Al alloys and corrosion properties
- Develop repair method
 - Acquire tools - borescopes, catheters
 - Mockup of repair
- Prevention of future problems
 - Exploring surface treatments of cooling lines
 - New instrumentation for system and procedures for monitoring

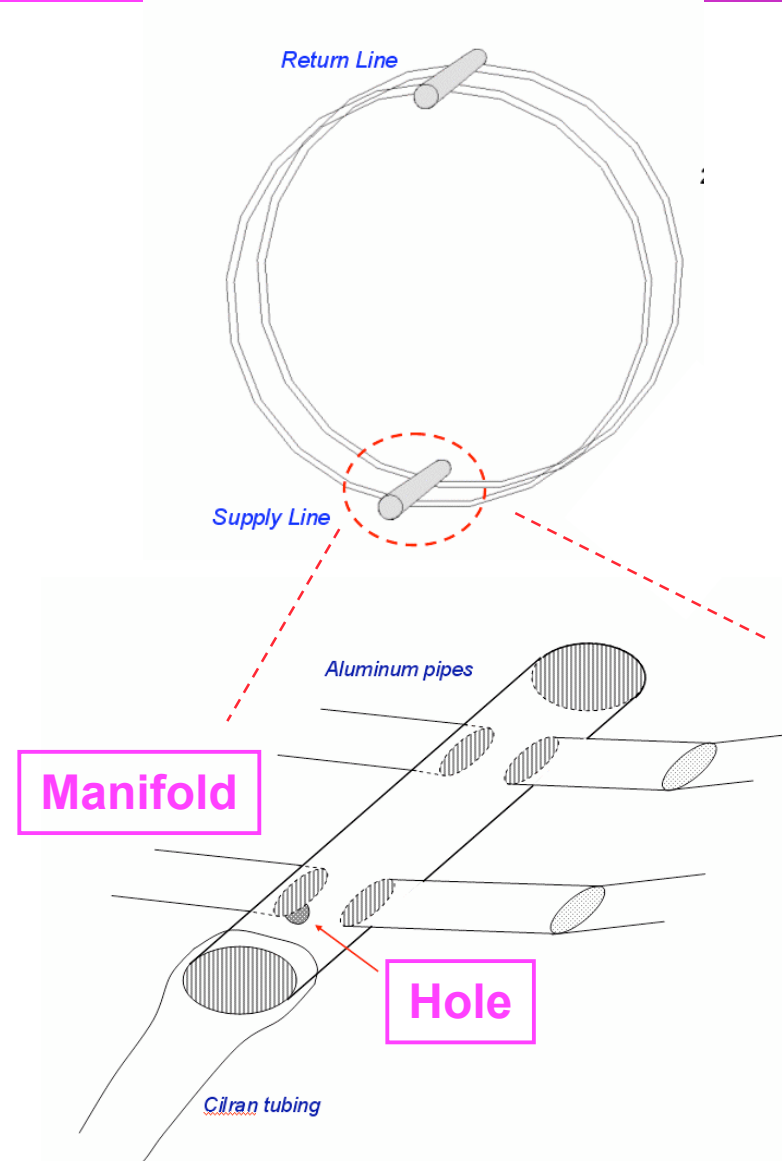


ILS/L00 PortCard Cooling



- Manifold - AL 6061-T6, 30mil wall
- Cooling Rings - AL 5052, 20mil wall
- Welded
- Inner surface area: 0.12m^2

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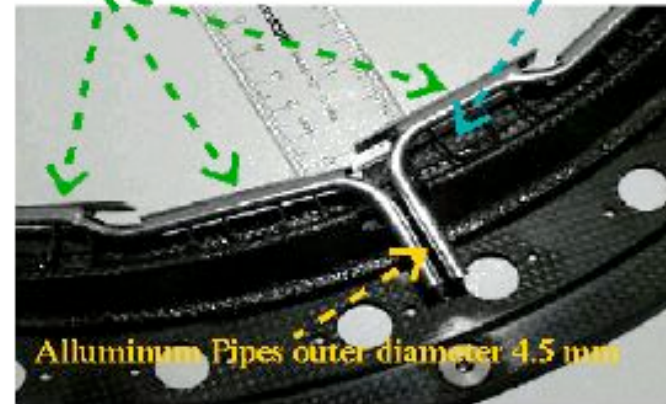
ISL Ladder Cooling

- Aluminum tubes (AL 1100)
 - ID 3.8mm or 4.0mm
 - Wall: 10mils
 - Total tubing: 50m
 - Inner surface area: 0.6m²
- Combined in sets of 4 or 5 via small manifolds
- Joints at manifolds and 90° bends use epoxy
- No welds

Space Frame Cooling System

Beryllium Ledges

Carbon Fiber Ribbon



Maximum of 9 ladders in one cooling channel
 $\Delta T(\text{IN-OUT}) \sim 1^\circ\text{C}$

coolant flowing in aluminum tubes attached to beryllium ledges mounted on space frame





Cause of Leak

- Erosion:
 - Unlikely: FEA of flow shows no turbulent flow
- Corrosion starting on microcracks in ovalized tubing:
 - No evidence in radio-micrographs or dye penetrant test
- Microbiologically Induced Corrosion (MIC)
 - Cause of MI cooling leak during commissioning
 - Tested coolant samples (March and June 2007) for MIC microbes
 - Consultant on MIC found no evidence of live or dead microbes in coolant
- Corrosion by acidic (conductive) coolant most probable
 - What made coolant acidic?
 - What are implications on other parts of the system?



ISL Coolant History

- Aug 2005: 100% water to 90/10 Water/Ethylene Glycol
- Mar 2006: Warm from 6C to 15C for shutdown work
 - Conductivity rises: $2\mu\text{Si/cm}$ to $>16\mu\text{Si/cm}$ (Full scale)
- May 2006: Conductivity remains high after cooling down
- Aug 2006: Conductivity $1200\mu\text{Si/cm}$
- Mar 2007: Conductivity $3000\mu\text{Si/cm}$, pH~2
- Apr 2007: Drain and refill system
 - Conductivity $700\mu\text{Si/cm}$, pH~2.8
- May 2007: Intensive de-ionization
 - Conductivity $<10\mu\text{Si/cm}$, pH~4.5
 - Leak develops



Source of Acidity

- Test at Argonne analytical chemistry lab using Ion Chromatography
 - Determine what anions are present
 - Preliminary result: prominent peaks in region expected for Formic and Acetic acid, don't see inorganic acids
 - Tests of references in progress
- Likely due to breakdown of ethylene glycol
 - Rate Increases with temperature
 - Can result from biological activity which is more likely at low concentrations of glycol



Looking for Aluminum

Performed Tests of coolant for metals

- Aug 2006 - nothing significant seen at few ppb level
- March 2007 - test was not sensitive enough (~1ppm)
- June 2007 - reanalyze March coolant and analyze current with sensitivity of few ppb
 - March sample: **Al ~1mg/l of coolant or ~0.7g of Al total**
 - June sample: Al ~0.07mg/l or ~0.05g of Al - consistent with dilution from drain and refill in April
 - Many other materials seen in March sample (Calcium, Iron, Chromium...) but not in June sample, likely from storing in steel barrel for 2 months (had tear in liner)
- Still evaluating full implications



Implication of Tests

- Dissolved aluminum: ~0.7g
 - Pitting in portcard manifolds ~6mg (4 pits observed on east, assume 4 more on west)
 - Uniform loss of 0.1mils from Al cooling lines would yield about 1g (minimum wall thickness 10mils)
 - Conclusion: Problem extends beyond observed pitting
- Some aluminum may have deposited on surfaces
 - May not count for all of the Aluminum removed from surfaces
- We have done visual inspection of few percent of the Aluminum surface area.



Vulnerability

- Ladder cooling construction more corrosion resistant than portcard cooling
 - Welds are corrosion weak point (all pits observed in or next to welds)
 - AL1100 (ladders) more corrosion resistant than 5052 and 6061
 - Ladder tubes have thinner walls
- Galvanic action in general not very likely
 - Significant distance of insulating tubing between Al and SS
- Rest of system is SS and much thicker walls
- Need visual inspection of ladder cooling lines and west portcard cooling
 - Summer shutdown



Repair Technique

- Leak will be repaired with epoxy
- Test: deposit epoxy over hole in Al with catheter
 - Wets and fills 30, 40mil holes when applied from above or below
 - Good bonding on surface contaminated with coolant
 - Cures at temperature of tube ~15C
- Testing real mockup
 - Down 1m of tubing using catheter and borescope
 - Tests filling holes in mockup of manifold today
- High confidence that we will not be burying a lurking problem
 - No MIC in action on surface



Plans for Access to Repair

- Preparing for repair before the shutdown
 - Target middle of next week (about July 11)
 - Duration 2-3 shifts
- Goals for access
 - Confirm leak location using borescope and catheter
 - Repair with epoxy
 - More information to use in preparation for shutdown
 - Get better images of damage in portcard manifolds using new borescopes/video equipment
- Procedure in preparation
 - Risk analysis in progress
- Make formal request by July 5



Work During Shutdown

- Examination of west portcard cooling and ladder cooling lines
 - Repair of any damage seen in portcard manifolds
 - If damage to ladder cooling lines may need to develop repair technique
- Likely drain and refill coolant to remove residual glycol
- Add instrumentation and larger de-ionizer
- Possible mitigation or prevention through coating of lines



Continuing Tasks

- Understanding source of problem
 - Corrosion tests being developed with samples of Al pieces
 - Research and tests of Glycol degradation
 - Consultation with corrosion experts
- Implications
 - What happens to remaining glycol (0.25%) when we warm up during shutdown?
 - Could SVX coolant degrade (30% glycol, colder)?
 - Will lurking damage result in future leaks?
- Mitigation actions
 - New instrumentation and procedures
 - Possible changes to coolant composition (eg passivation additives)

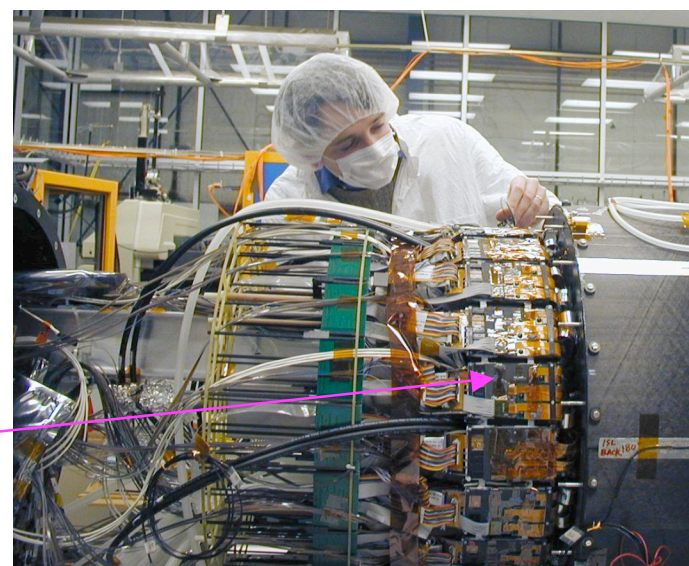
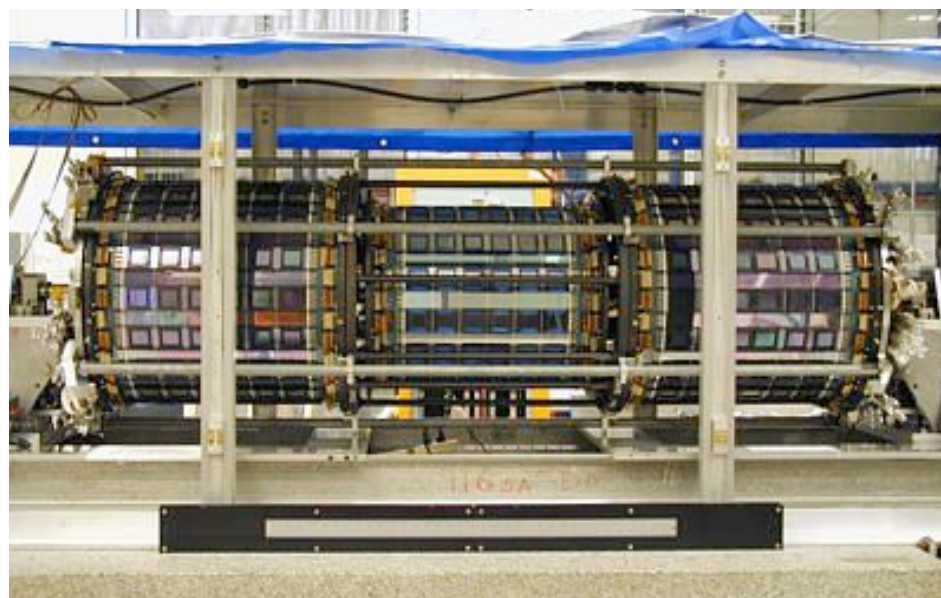
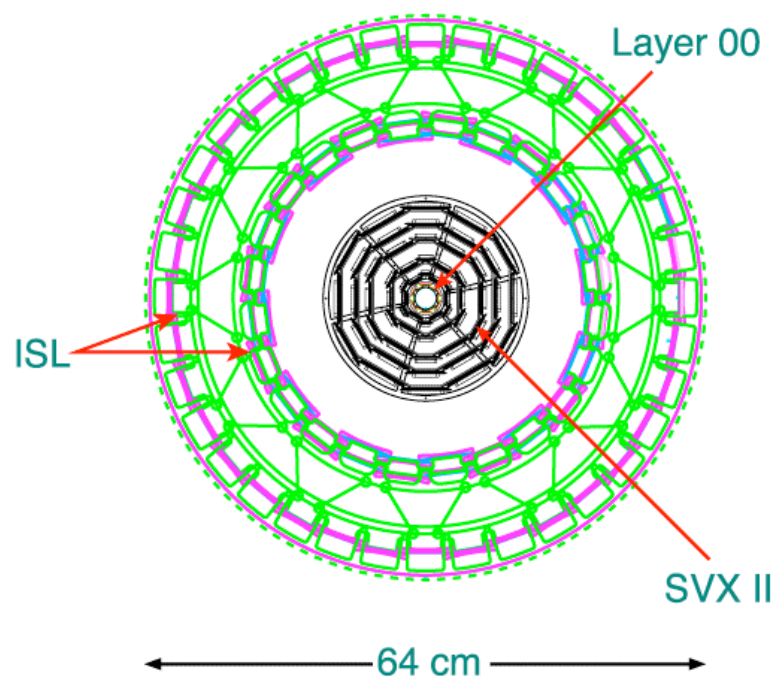


Conclusions

- Significant Progress on understanding source of problem
 - Most certainly corrosion
 - Investigations will continue for some time yet
 - Know enough to execute repair
- Repair technique well understood
- Almost ready to execute repair - next week?
- Preparing for shutdown investigation and possible repair
- Still many avenues to follow in investigation



CDF Silicon Detectors



ISL/L00 Portcards

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History of Cooling System

